



74VHCT04A Hex Inverter

Features

- High speed: $t_{PD} = 4.7$ ns (Typ.) at $T_A = 25$ °C
- High noise immunity: $V_{IH} = 2.0V$, $V_{IL} = 0.8V$
- Power down protection is provided on all inputs and outputs
- Low noise: V_{OLP} = 1.0V (Max.)
- Low power dissipation: $I_{CC} = 2\mu A$ (Max.) @ $T_A = 25$ °C
- Pin and function compatible with 74HCT04

General Description

The VHCT04A is an advanced high speed CMOS Inverter fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

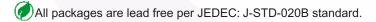
The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

Protection circuits ensure that 0V to 7V can be applied to the input pins without regard to the supply voltage and to the output pins with $V_{CC} = 0V$. These circuits prevent device destruction due to mismatched supply and input/output voltages. This device can be used to interface 3V to 5V systems and two supply systems such as battery backup.

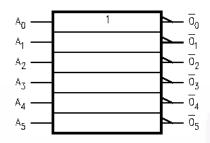
Ordering Information

| Order Number | Package Number | Package Description | | | |
|--------------|-------------------|--|--|--|--|
| 74VHCT04AM | M14A | 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow | | | |
| 74VHCT04ASJ | M14D | 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide | | | |
| 74VHCT04AMTC | MTC14 | 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide | | | |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



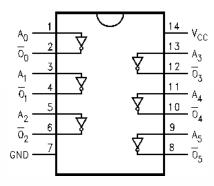
Logic Symbol



Pin Description

| Pin Names | Description |
|------------------|-------------|
| A _n | Inputs |
| \overline{O}_n | Outputs |

Connection Diagram



Truth Table

| Α | ō |
|---|---|
| L | Н |
| Н | L |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Rating |
|------------------|--|---------------------------------|
| V _{CC} | Supply Voltage | -0.5V to +7.0V |
| V _{IN} | DC Input Voltage | -0.5V to +7.0V |
| V _{OUT} | DC Output Voltage | |
| | Note 1 | -0.5V to V _{CC} + 0.5V |
| | Note 2 | -0.5V to 7.0V |
| I _{IK} | Input Diode Current | –20mA |
| I _{OK} | Output Diode Current ⁽³⁾ | ±20mA |
| I _{OUT} | DC Output Current | ±25mA |
| I _{CC} | DC V _{CC} /GND Current | ±50mA |
| T _{STG} | Storage Temperature | −65°C to +150°C |
| TL | Lead Temperature (Soldering, 10 seconds) | 260°C |

Recommended Operating Conditions⁽⁴⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Rating |
|---------------------------------|--|-----------------------|
| V _{CC} | Supply Voltage | 4.5V to +5.5V |
| V _{IN} | Input Voltage | 0V to +5.5V |
| V _{OUT} | Output Voltage | |
| | Note 2 | 0V to V _{CC} |
| | Note 3 | 0V to 5.5V |
| T _{OPR} | Operating Temperature | -40°C to +85°C |
| t _r , t _f | Input Rise and Fall Time, V _{CC} = 5.0V ±0.5V | 0ns/V ~ 20ns/V |

Notes:

- 1. HIGH or LOW state. I_{OUT} absolute maximum rating must be observed.
- 2. $V_{CC} = 0V$.
- 3. $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active).
- 4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| | | | | | Т | _ A = 25° | С | T _A = - | –40°C 85°C | |
|------------------|---|---------------------|---|---------------------------------|------|--------------|------|--------------------|---------------|-------|
| Symbol | Parameter | V _{CC} (V) | Con | ditions | Min. | Тур. | Max. | Min. | Max. | Units |
| V _{IH} | HIGH Level Input | 4.5 | | | 2.0 | | | 2.0 | | V |
| | Voltage | 5.5 | | | 2.0 | | | 2.0 | | |
| V _{IL} | LOW Level Input | 4.5 | | | | | 0.8 | | 0.8 | V |
| | Voltage | 5.5 | | | | | 0.8 | | 0.8 | |
| V _{OH} | HIGH Level Output | 4.5 | $V_{IN} = V_{IH}$ | $I_{OH} = -50\mu A$ | 4.40 | 4.50 | | 4.40 | | V |
| | Voltage | | | $I_{OH} = -8mA$ | 3.94 | | | 3.80 | | |
| V _{OL} | LOW Level Output | 4.5 | $V_{IN} = V_{IH}$ | $I_{OL} = 50 \mu A$ | | 0.0 | 0.1 | | 0.1 | V |
| | Voltage | | | $I_{OL} = 8mA$ | | | 0.36 | | 0.44 | |
| I _{IN} | Input Leakage Current | 0 – 5.5 | V _{IN} = 5.5V | or GND | | | ±0.1 | | ±1.0 | μA |
| I _{CC} | Quiescent Supply Current | 5.5 | $V_{IN} = V_{CC}$ | or GND | | | 2.0 | | 20.0 | μA |
| I _{CCT} | Maximum I _{CC} /Input | 5.5 | V _{IN} = 3.4V Inputs = V ₀ | , Other _{CC} or GND | | | 1.35 | | 1.50 | mA |
| I _{OFF} | Output Leakage Current (Power Down State) | 0.0 | V _{OUT} = 5.5 | 5V | | | 0.5 | | 5.0 | μA |

Noise Characteristics

| | | | | $T_A =$ | 25°C | |
|---------------------------------|--|-----------------------|-------------|---------|-------|-------|
| Symbol | Parameter | Conditions | $V_{CC}(V)$ | Тур. | Limit | Units |
| V _{OLP} ⁽⁵⁾ | Quiet Output Maximum Dynamic V _{OL} | $C_L = 50pF$ | 5.0 | 0.8 | 1.0 | V |
| V _{OLV} ⁽⁵⁾ | Quiet Output Minimum Dynamic V _{OL} | $C_L = 50pF$ | 5.0 | -0.8 | 1.0 | V |
| V _{IHD} ⁽⁵⁾ | Minimum HIGH Level Dynamic Input Voltage | $C_L = 50pF$ | 5.0 | | 2.0 | V |
| V _{ILD} ⁽⁵⁾ | Maximum LOW Level Dynamic Input Voltage | C _L = 50pF | 5.0 | | 0.8 | V |

Note:

5. Parameter guaranteed by design.

AC Electrical Characteristics

| | | | | т | - A = 25° | С | | -40°C 85°C | |
|-------------------------------------|----------------------------------|---------------------|------------------------|------|--------------|------|------|---------------|-------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min. | Тур. | Max. | Min. | Max. | Units |
| t _{PHL} , t _{PLH} | Propagation Delay | 5.0 ± 0.5 | C _L = 15pF | | 4.7 | 6.7 | 1.0 | 7.5 | ns |
| | | | C _L = 50pF | | 5.5 | 7.7 | 1.0 | 8.5 | |
| C _{IN} | Input Capacitance | | V _{CC} = Open | | 4 | 10 | | 10 | pF |
| C _{PD} | Power Dissipation Capacitance | | (6) | | 17 | | | | pF |

Note:

6. C_{PD} is defined as the value of the internal equivalent capacitance, which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:
I_{CC} (Opr.) = C_{PD} • V_{CC} • f_{IN} + I_{CC} / 6 (per gate)

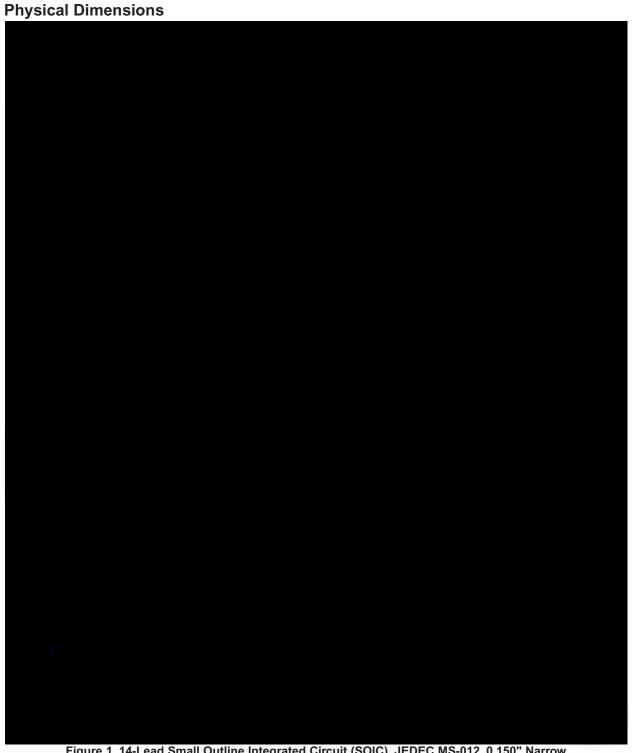


Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/

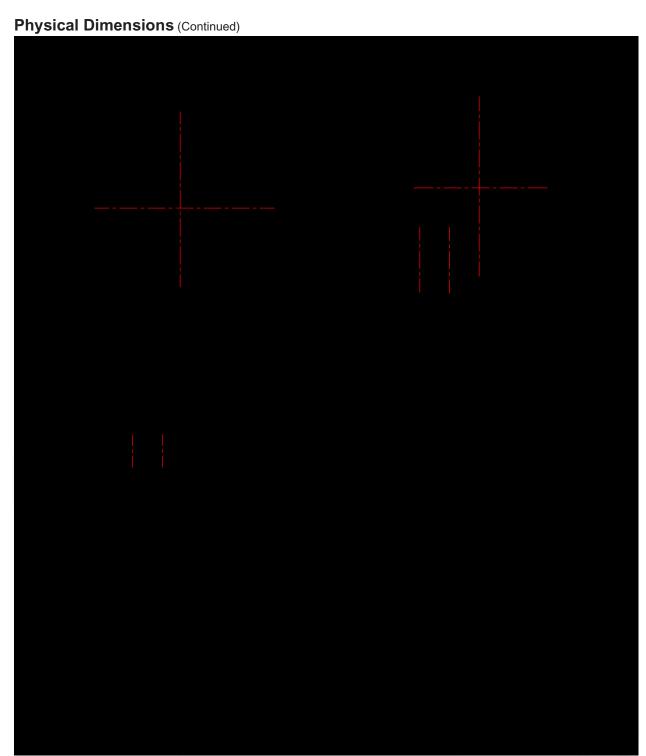
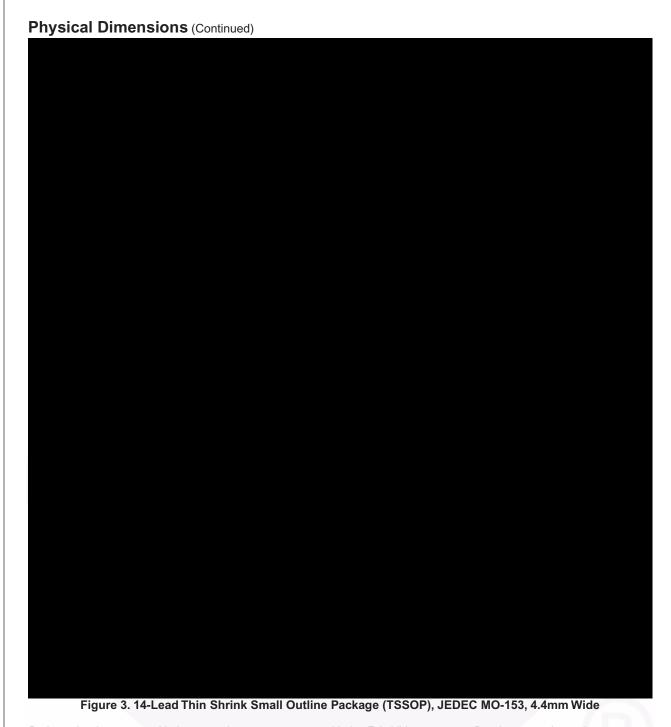


Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/



Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/





pubblicance, and is not intended to be an exhaustive list of all such trademains

ACEx[®]
Build it Now™
CorePLUS™
CROSSVOLT™
CTL™

Current Transfer Logic™ EcoSPARK[®] EZSWITCH™ *

Fairchild[®]

Fairchild Semiconductor[®] FACT Quiet Series™

FACT[®] FAST[®] FastvCore™ FlashWriter[®]* FPS™ FRFET®

Global Power ResourceSM

Green FPS™

Green FPS™ e-Series™ GTO™

i-Lo™ IntelliMAX™ ISOPLANAR™ MegaBuck™

MICROCOUPLERTM
MicroFETTM

MicroPak™ MillerDrive™ Motion-SPM™ OPTOLOGIC® OPTOPLANAR® PDP-SPM™
Power220®
Power247®
POWEREDGE®
Power-SPM™
PowerTrench®
Programmable Active Droop™

Programmable Active Droop™ QFET®

QSTM

QT Optoelectronics™ Quiet Series™ RapidConfigure™ SMART START™

SPM[®]

STEALTH™
SuperFET™
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8

SyncFET™
SYSTEM®
GENERAL

The Power Franchise®

the Wer franchise
TinyBoost™
TinyBuck™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
SerDes™
UHC®

Ultra FRFET™
UniFET™
VCX™

* EZSWITCH™ and FlashWriter[®] are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS
HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE
APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS
PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S
WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to |